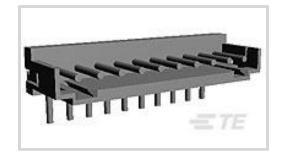
292143-4 - ACTIVE

AMP CT

TE Internal #: 292143-4 PCB Mount Header, Right Angle, Wire-to-Board, 4 Position, 2 mm [. 079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > CT 2mm Header Assembly: Right Angle



Connector System: Wire-to-Board

Number of Positions: 4

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Right Angle

All CT 2mm Header Assembly: Right Angle (176)

Features

Product Type Features

Connector System

Header Type

Wire-to-Board

Partially Shrouded



| Sealable | No |
|---|-----------------------------|
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |
| Configuration Features | |
| Number of Positions | 4 |
| Number of Rows | 1 |
| PCB Mount Orientation | Right Angle |
| Electrical Characteristics | |
| Operating Voltage | 125 VAC |
| Body Features | |
| Primary Product Color | Natural |
| Contact Features | |
| Contact Mating Area Length | 4.5 mm[.177 in] |
| PCB Contact Termination Area Plating Material Thickness | 1 – 2 µm[39.37 – 78.73 µin] |
| | |

PCB Mount Header, Right Angle, Wire-to-Board, 4 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



| Contact Layout Mating Pin Diameter | Inline .6 mm[.024 in] |
|--|-----------------------------|
| | .6 mm[.024 in] |
| | |
| Contact Mating Area Plating Material Thickness | 1 – 2 μm[39.37 – 78.73 μin] |
| Contact Shape & Form | Round |
| Contact Mating Area Plating Material Finish | Matte |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Tin |
| Contact Type | Pin |
| Contact Current Rating (Max) | 4 A |
| Termination Features | |
| Round Termination Post & Tail Diameter | .6 mm[.024 in] |
| Termination Post & Tail Length | 3.2 mm[.126 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Alignment Type | Polarization |
| Mating Retention | Without |
| Panel Mount Feature | With |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | Without |
| Housing Features | |
| Housing Material | Nylon 66 |
| Centerline (Pitch) | 2 mm[.079 in] |
| Dimensions | |
| Connector Length | 9.8 mm[.386 in] |
| Connector Height | 8.8 mm[.346 in] |
| Connector Width | 4 mm[.157 in] |
| PCB Thickness (Recommended) | .8 mm[.031 – .063 in] |
| Usage Conditions | |
| | -40 – 105 °C[-40 – 105 °F] |

PCB Mount Header, Right Angle, Wire-to-Board, 4 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



Operation/Application

| Assembly Process Feature | Pick and Place Cover |
|---|----------------------|
| Circuit Application | Power & Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Quantity | 1000 |
| Packaging Type | Bag, Box |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Wave solder capable to 265°C

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

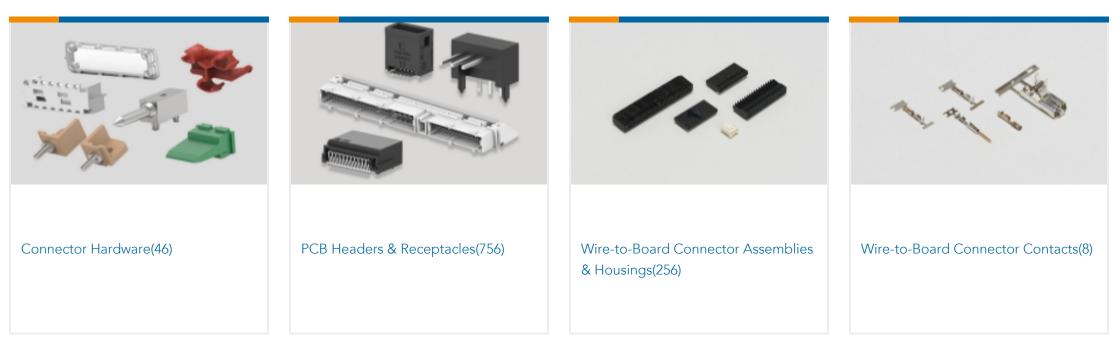
Compatible Parts

PCB Mount Header, Right Angle, Wire-to-Board, 4 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT

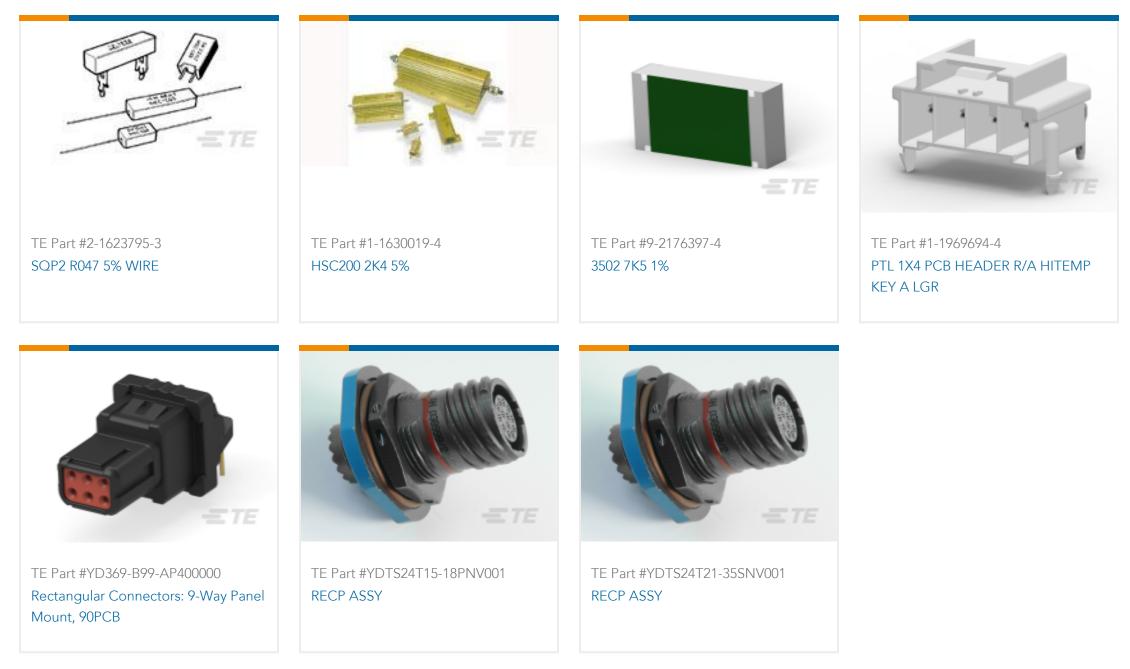




Also in the Series AMP CT



Customers Also Bought



Documents

Product Drawings CT POST HDR ASSY 4P H W/O KINK

English

CAD Files

3D PDF

3D

PCB Mount Header, Right Angle, Wire-to-Board, 4 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMP CT



Customer View Model

ENG_CVM_CVM_292143-4_O.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_292143-4_O.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_292143-4_O.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications AMP COMMON TERMINATION (CT), CONNECTOR, 2mm PITCH, M/T TYPE, LEAD FREE VERSION

Japanese

Product Specification

Japanese